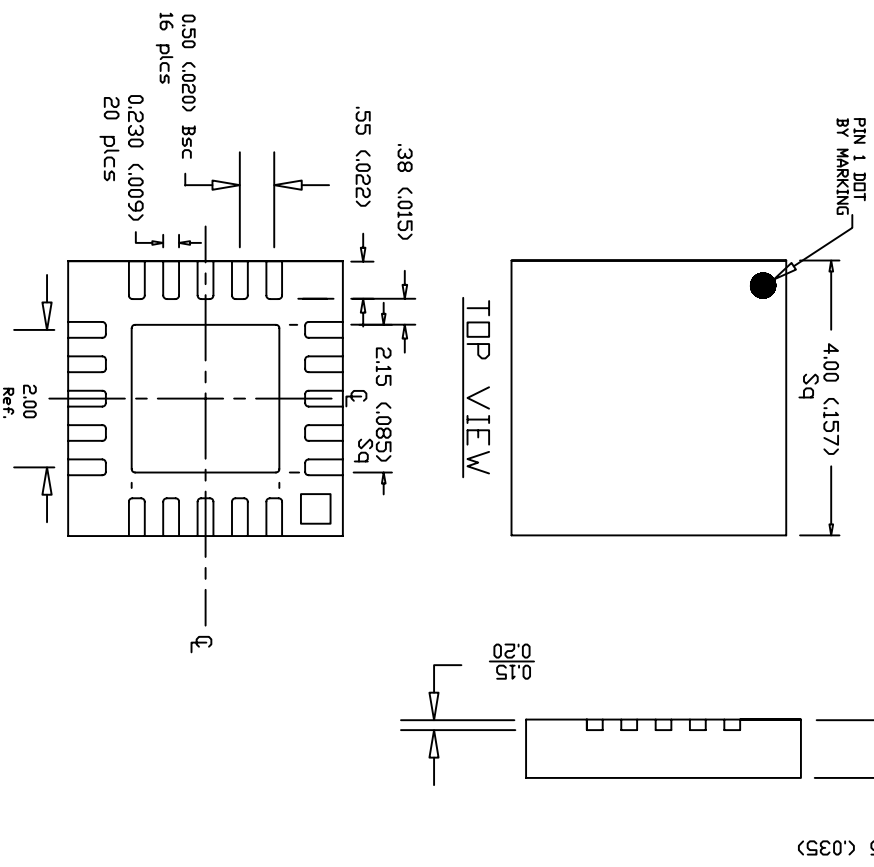


UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN mm (Inches) PER ASSEMBLY PRACTICES ARE: DECIMAL ANGLE XX ±.05 (.002) ±1/2	
MATERIAL(S):	See Note
FINISH:	See Notes

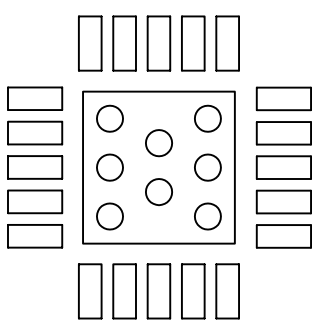


**TOP VIEW**

- Notes:
1. Base Metal - Copper Dlnh 194
  2. Lead Finish  
Basic PN - Sn/Pb Sn =>80%  
Z option - 100% Matte Sn - .01 (.0004) thk min

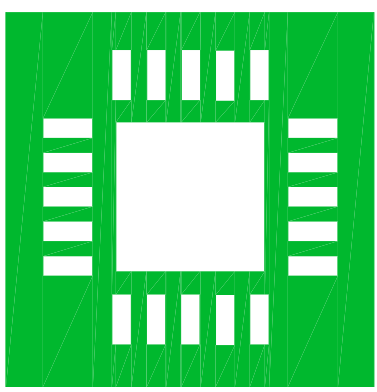
- Do Not Scale Hard Copy -

Caution: The Land Patterns and Solder Mask shown are generic for this package. Refer to product data sheet for any required variations specific to an application.



Scale 10:1

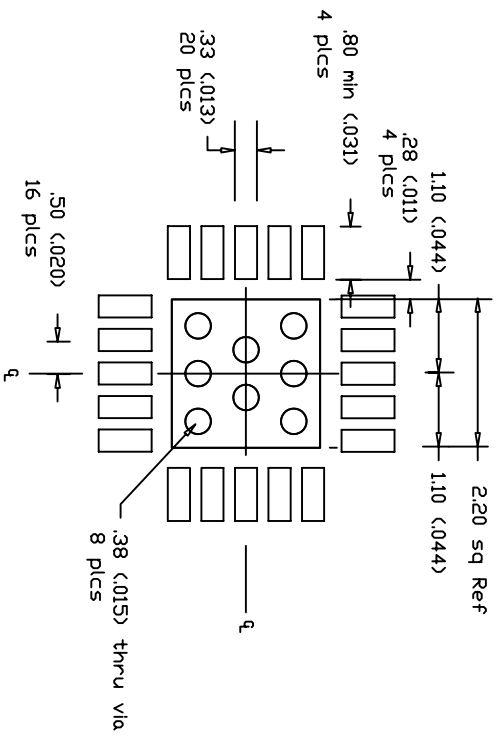
- Generic Land Pattern -



Scale 10:1

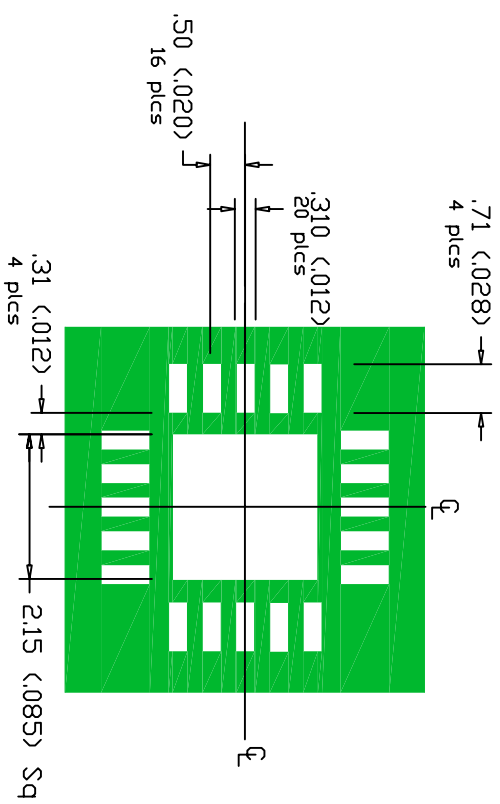
- Generic Solder Mask Opening -

Package Type: 4x4 mm 20 ld QFN w/.5mm Lead Pitch (Unisem)		
SMDI Package Type: XXX-XX44		
Dwg No. MP0-104124	Sht 1 of 2	REV B



Scale 10:1

- Generic Land Pattern -



Scale 10:1

- Generic Solder Mask Opening -

- Do Not Scale Hard Copy -



Package Type:

4x4 mm 20 ld QFN w/.5mm Lead Pitch

SMDI Package Type: XXX-XX44

Dwg No. MPO-104124

Sht 2 of 2 REV B